

Altos | R R380 F3

The Altos R380 F3 is a robust two-socket 2U system that is ideal for almost any application. This dynamic system can function as a head node, for virtualization purposes, or as a storage system for your HPC (High-Performance Computing) and technical computing environments. Extremely expandable and highly efficient, this system is a powerful core for your most demanding data-center needs.

Extremely powerful

The R380 F3 supports up to two Intel[®] Xeon[®] E5-2600 v3 product family processors, and high-performance DDR4 memory occupying twenty-four DIMM slots. There is no shortage of storage capability with up to twelve 3.5" or twenty-four 2.5" front-accessible, hot-swap hard drives, two 2.5" internal drive bays and two 2.5" rear-accessible hot-swap drive bay options. Hard drives can be configured in 12Gb/s SAS RAID and SAS HBA for increased performance and data availability.

Highly efficient

As with all Acer rack servers, the R380 F3 uses only 80 PLUS-certified power supplies. This server can be equipped with up to two 750 W or 1100 W 80 PLUS Platinum-level power supplies. Combine this with Load Reduced DIMM memory modules and the latest power-saving chipset technologies, this system delivers maximum performance with minimum power-draw. Six managed, hot-swappable fans keep the system running cool at all times.

Flexible and robust I/O

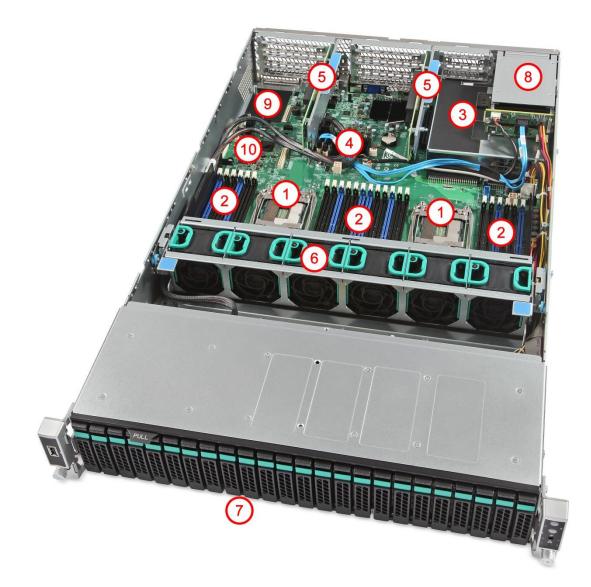
Qualified to work in any environment, this system has dual 10 Gigabit or Gigabit Ethernet connectors onboard. It also has up to 7 PCIe 3.0 slots and 1 PCIe 2.0 slot, maximizing your expansion options. In addition, dedicated I/O module and SAS module slots save customers valuable PCIe expansion. Users can rest assured the R380 F3 will keep up in any high-performance scenario.



Product views

Internal view





- 1. 2 x Intel[®] Xeon[®] E5-2600 v3 family processors
- 2. 24 x DDR4 ECC Registered/Load Reduced DIMMs
- 3. 2 x 750 W / 1100 W Platinum-level AC or 2 x 750 W Gold-level DC power supplies (1+0/1+1 redundant, hot-swappable)
- 4. Onboard SATA RAID connections
- 5. 7 x PCle 3.0 and 1 x PCle 2.0 slots across three risers
- 6. Hot-swappable redundant system fans
- 7. Hot-swappable drive bays (front)
- 8. Hot-swappable 2.5" SSD drive bays (rear, optional)
- 9. $1 \times 1/0$ module
- 10. 1 x SAS RAID module



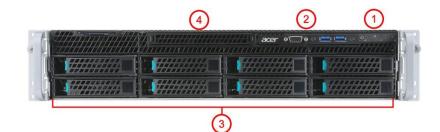
Front Views

Front I/O (12 x 3.5")

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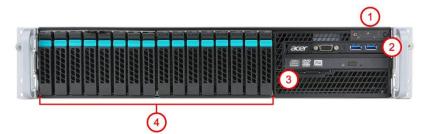
- 1. Power button, LED indicators: power, HDD activity, LAN, system ID
- 2. Rack locking screw
- 3. Up to 12 x 3.5" SATA / SAS HDDs or 2.5" SSDs
- 4. Front USB 2.0

Front I/O (8 x 3.5")



- 1. Power button, LED indicators: power, HDD activity, LAN, system ID
- 2. Front VGA and 2 x USB 3.0
- 3. Up to 8 x 3.5" SATA / SAS HDDs or 2.5" SSDs
- 4. Optional slimline optical drive

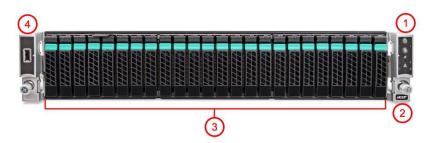
Front I/O (16 x 2.5")



- 1. Power button, LED indicators: power, HDD activity, LAN, system ID
- 2. Front VGA and 2 x USB 3.0
- 3. Optional slimline optical drive
- 4. Up to 16 x 2.5" SATA / SAS HDDs and SSDs (with an option to replace four hard drives with four PCIe SFF/NVMe SSDs)

Front I/O (24 x 2.5")

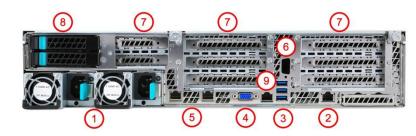




- 1. Power button, LED indicators: power, HDD activity, LAN, system ID
- 2. Rack locking screw
- 3. Up to 24 x 2.5" SATA / SAS HDDs and SSDs (with an option to replace four hard drives with four PCIe SFF/NVMe SSDs)
- 4. Front USB 2.0

Rear View

Rear I/O



- 2 x 750 W / 1100 W 80 PLUS Platinum-level AC or 2 x 750 W 80 PLUS Gold-level DC power supplies (1+0/1+1 redundant, hot-swappable)
- 2. Management port (RJ-45)
- 3. 3 x USB 3.0 ports
- 4. Video port
- 5. 2 x Gigabit or 10Gigabit LAN ports (RJ-45)
- 6. Serial Port B (optional)
- 7. PCle expansion via riser cards
- 8. 2 x 2.5" SSDs (hot-swappable, optional)
- 9. Serial Port A (RJ-45)



Product Specifications

What's New

- New Intel[®] Xeon[®] E5-2600 v3 processors
- DDR4 memory
- Rear-accessible, hot-swappable drive bays
- Supports four PCIe SFF/NVMe SSDs
- USB 3.0 ports
- Dual-port 10 Gigabit Ethernet on board
- Smart Server Manager with improved management functionality

Processors and Chipset

- Up to two Intel[®] Xeon[®] E5-2600 v3 family processors
- Chipset: Intel[®] C612

Memory

• 24 x DDR4 Registered / Load Reduced DIMMs

Network Controllers

- Dual-port Ethernet controller
- Intel[®] X540 (10GbE) or Intel I350 (1GbE)

Storage

- Hard disk form factor: 3.5" or 2.5"
- Type: SAS / SATA / SSD with hot-plug capability
- Front: up to 12 x 3.5" or 24 x 2.5" hard drives or SSDs (with an option to replace four hard drives with four PCIe SFF/NVMe SSDs)
- Rear: up to 2 x 2.5" SSDs (optional)
- Internal: up to 2 x 2.5" SSDs (optional)
- Slimline optical drive (optional)

Storage Controllers

- Intel[®] C612 chipset with 10 x 6 Gb/s SATA ports
 - 2 x single port SATA connectors
 - 2 x 4-port mini SAS HD connectors
 - 1 x eUSB 2x5 pin connector for 2mm low profile eUSB SSDs
- Intel RSTe 4.1 embedded software SATA RAID
- Intel Embedded Server RAID Technology 2 (ESRT2) 1.41 with optional RAID 5 key support
- Optional Hardware SAS RAID with RAID 0, 1, 5, 6, 10, 50, 60 support



Expansion slots

- Three riser slots provide:
 - Riser slot 1:
 - 3-slot riser card: 2 x PCle[®] 3.0 ×8 (x16 connector) and 1 x PCle[®] 3.0 ×8 (x8 connector), or
 - 2-slot riser card: 1 x PCle 3.0 x16 (x16 connector) and 1 x PCle 3.0 x 8 (x8 connector)
 - Riser slot 2:
 - 3-slot riser card: 2 x PCle[®] 3.0 ×8 (x16 connector) and 1 x PCle[®] 3.0 ×8 (x8 connector), or
 - 2-slot riser card: 1 x PCle 3.0 x16 (x16 connector) and 1 x PCle 3.0 x 8 (x8 connector)
 - Riser slot 3:
 - 2-slot riser card: 1 x PCle 3.0 ×8 (x8 connector) and 1 x PCle 2.0 x 4 (x8 connector)
- 1 x I/O module expansion slot
- 1 x SAS RAID module expansion slot

Management

- Acer Smart Server Manager
- Embedded BMC controller with IPMI 2.0 compatibility
- System ID LED buttons, System Health LED
- Smart Console remote monitoring and optional KVM over IP management to OS level
- Optional Local Control Panel

BIOS

- UEFI BIOS
- SMBIOS 2.0

Deployment/Serviceability

- BIOS Update Tool
- IPMI Firmware Update Tool

Operating Systems

- Windows Server 2012 R2
- Red Hat Enterprise Linux 6.5
- SUSE Linux Enterprise Server 11 SP3
- VMware ESXi[™] 5.5

Graphics

- Integrated 2D video controller
- 16 MB DDR3 memory

Chassis/Form Factor

• 2U rack-optimized



Power Supply

- 1+0/1+1 redundant, hot-swappable power supply units. Three power supply options:
 - 750 W 80 PLUS[®] Platinum-certified AC power supply
 - 1100 W 80 PLUS[®] Platinum-certified AC power supply
 - 750 W 80 PLUS® Gold-certified DC power supply

Security

- Administrator/user password
- Power-on password
- Setup password
- Device boot control
- Secure command line interface (SSH)
- Secure browser interface (Secure socket layer SSL support)
- Secure IPMI LAN interface (Authentication, Integrity, and Confidentiality algorithm)

Regulatory Compliant Standards

EMC

- FCC (Class A)
- CE (Class A)
- BSMI (Class A)
- CCC

Safety

- MET
- CB

Environmental Specifications

•		
Dimensions	750 W SKU	439 (W) x 769 (D) x 89 (H) mm (17.25 x 30.25 x 3.5 inches)
	1100 W SKU	439 (W) x 793.8 (D) x 89 (H) mm (17.25 x 31.25 x 3.5 inches)
System inlet temperature	Operating	10° - 35° C (50° - 95° F)
	Non-operating	-40° - 70° C (-40° - 158° F)
Relative humidity	Non-operating	50 - 90 %
Relative numbercy	Non operating	50 90 %
Acoustics	ldle	
ACOUSLICS		
	LWAd	< 7.0 BA
	Operating	
	1 5	. 7.0 DA
	LWAd	< 7.0 BA
Power	Rated Steady –state	750 W or 110 W
	5	
	power	



Technical specifications

PCle[®] specifications

The primary I/O bus for the main board is PCIe Gen3. The following table lists the characteristics of the PCI-E bus segments. Details about each bus segment follow the table.

NOTE: The signaling bit rate of PCI Express is 8.0 Gbit/s one direction per lane for Gen 3.

Riser	Riser Card	Location	Connector	Туре	Bus	Voltage	CPU ²	Add-in Card Form
Slot	Туре				Width ¹			Factor
1	3-slot Riser	Top Slot	x16	PCle® Gen3	x8	3.3V	1	Full height/Full length
	Card	Middle Slot	x16	PCle® Gen3	x8	3.3V	1	Full height/Full length
		Bottom Slot	x8	PCle® Gen3	x8	3.3V	1	Full height/Half length
	2-slot Riser	Top Slot	x16	PCle® Gen3	x16	3.3V	1	Full height/Full length
	Card	Bottom Slot	x8	PCle® Gen3	x8	3.3V	2	Full height/Half length
2	3-slot Riser	Top Slot	x16	PCle® Gen3	x8	3.3V	2	Full height/Full length
	Card	Middle Slot	x16	PCle® Gen3	x8	3.3V	2	Full height/Full length
		Bottom Slot	x8	PCle® Gen3	x8	3.3V	2	Full height/Half length
	2-slot Riser	Top Slot	x16	PCle® Gen3	x16	3.3V	2	Full height/Full length
	Card	Bottom Slot	x8	PCle® Gen3	x8	3.3V	2	Full height/Half length
3	Low profile	Top Slot	x8	PCle® Gen2	x4	3.3V	2	Low-profile
	Riser Card	Bottom Slot	x8	PCle® Gen3	x8	3.3V	2	Low-profile

NOTE:

- 1. Indicates the number of physical electrical lanes running to a PCIe[®] connector.
- 2. CPU 2 indicates that a second CPU is required to access that specific PCle[®] slot.
- 3. If only one CPU is used:

It is not possible to use more than the top two slots on a 3-slot riser card or the top slot on a 2-slot riser card (in riser slot 1).

Riser slot 2 and Riser slot 3 cannot be used.

Two riser card assemblies are used, one for slot 1, and a butterfly configuration for slots 2 and 3.

• Riser slot 1



• Riser slots 2 and 3

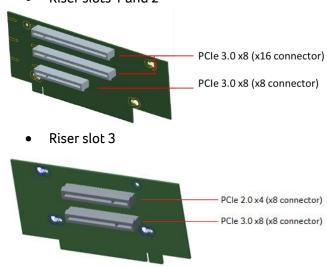


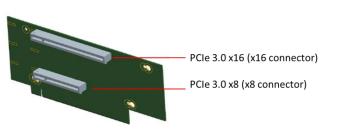




Riser card options below, up to three can be installed

• Riser slots 1 and 2





Onboard storage specifications

ltem	Description
Controller	Intel [®] C612 Platform Controller Hub
Simultaneous drive transfer channels	10 onboard SATA ports
	• AHCI SATA controller: 4 x SATA ports from the Mini SAS HD
	connector and 2 x SATA ports on the server board
	 AHCI sSATA controller: 4 x SATA ports from the Mini SAS HD
	connector on the server board.
Max throughput per channel	6 Gb/s
Data transfer method	Non-RAID mode
	RAID mode
Drive type supported	Serial ATA
RAID levels support	Default: Intel ESRT2 SATA RAID 0, 1, 5, 10 (RAID 5 requires key) or
	Intel RSTe software SATA RAID 0, 1, 5, 10 (Windows OS support only)
RAID function support	Supports multiple logical volumes
	 Setup through ROM based Array Configuration Utility
	Installation scripting support
RAID OS support	Windows Server 2012 R2
RAID OS support	
	Red Hat Enterprise Linux 6.5
	SuSE Linux Enterprise Server 11
Additional features	 NCQ (Native Command Queuing)
	 AHCI (Advanced Host Controller Interface)
Onboard LAN specifications	
ltem	Description
Controller	Dual-port Intel [®] I350 Ethernet Controller (1GbE) or Dual-port Intel
	X540 Ethernet Controller (10GbE)
Network interface	10Base-T / 100Base-TX / 1000Base-T / 10GBase-T
Compatibility standards	 IEEE 802.3 Ethernet interface for 10BASE-T
· •	 IEEE 802.3ab Ethernet interface for 1000BASE-T
	IEEE 802.3u Ethernet interface for 100BASE-TX
	 IEEE 802.3an Ethernet interface for 10GBASE-T

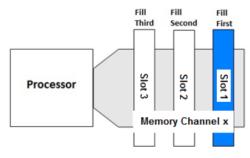


ltem	Description
Manageability	NC-SI, SMBus
	PXE, iSCSI boot
Virtualization acceleration	 Virtual Machine Device Queues (VMDq)
	PCI-SIG SR-IOV implementation
Connector	RJ-45
Supported cable type	X540 (10GbE): CAT-6/CAT-6A
	I350 (1GbE): CAT-5/CAT-5e
Memory specifications and population	
ltem	Description
Supported memory types	• Registered DDR4 1600 / 1866 / 2133 MHz
	 Load Reduced DDR4 1600 / 2133 MHz
	ECC-enabled
	Integrated on-die thermal sensors (TROD)
	NOTE: Acer does not qualify mixed memory configurations of memory type, capacity or make.
Population	 Farthest fill first rule on any channel (populate blue slot /
i opulation	Slot 1 first)
	• Install DIMMs in order (CPU-1: Channels A, B, C and D; CPU-
	2: Channels E, F, G and H)
	• Only remove DIMM blanks when populating memory in that
	slot
	 Maximum of 8 ranks can be installed on any one channel
	Do not mix DIMM types (RDIMM or LRDIMM) and frequencies
	or latencies within or across CPUs
	Population per CPU by DIMM type listed below. NOTE : Support for 16 / 32 / 64 GB DIMMs may vary by regional
	NOTE. Supportion 107 527 04 00 DIMMS may vary by regional

availability.

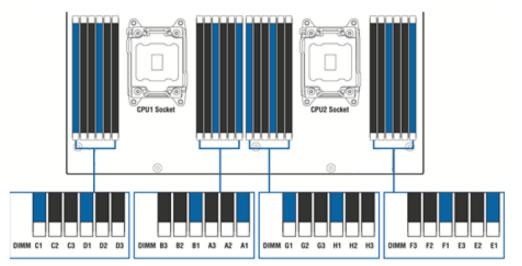
A CPU must be populated for memory to be read.

Memory support and population





Processor Socket 1										Proc	essor	Sock	et 2										
	(0)			(1)			(2)			(3)			(0)			(1)			(2)			(3)	
Ch	nanne	IA	Cł	hanne	IВ	Ch	nannel	С	Ch	nannel	D	Ch	nannel	E	Cl	hanne	IF	Ch	annel	G	Ch	nanne	Н
A1	A2	A3	B1	B2	B3	C1	C2	C3	D1	D2	D3	E1	E2	E3	F1	F2	F3	G1	G2	G3	H1	H2	H3



Туре	Ranks Per DIMM and Data	Per DIMM Capacity (GB) DIMM d Data			Speed (MT/s); Voltage (V); Slot per Channel (SPC) and DIMM per Channel (DPC) 3 Slots per Channel				
	Width			1 DPC	2 DPC	3 DPC			
		4 Gb	8 Gb	1.2V	1.2V	1.2V			
RDIMM	SRx4	8GB	16GB	2133	1866	1600			
RDIMM	SRx8	4GB	8GB	2133	1866	1600			
RDIMM	DRx8	8GB	16GB	2133	1866	1600			
RDIMM	DRx4	16GB	32GB	2133	1866	1600			
LRDIMM	QRx4	32GB	64GB	2133	2133	1600			

Independent mode:

- Also known as performance mode, each DDR channel is addressed individually via burst lengths of 8 bytes.
- All CPUs support SECDED ECC with x8 DRAMs.
- All CPUs support SDDC with x4 DRAMs.

Lockstep mode:

- Also known as RAS mode, each pair of channels shares a Write Push Logic unit to enable lockstep.
- Channels are paired together as a domain. For CPU1, channels A and B, and channels C and D. For CPU2, channels E and F, and channels G and H.
- All CPUs support SDDC with x4 or x8 DRAMs.

Memory RAS mode:

- RAS mode that require matching populations.
- Same slot position across channels must hold the same DIMM type (ranks, banks, rows and column)

Intra-Socket Memory Mirroring mode:

• For mirroring mode, the memory image in channel A is maintained the same as channel C and channel B is maintained the same as channel D. Therefore, the effective size of memory is reduced by one-half.



• The DIMM configuration in mirrored channels must be identical. Channel A & channel C with identical DIMMs and also channel B & channel D with identical DIMMs. The DIMM type, size, manufacturer should be the same.

Rank Sparing mode:

An unused spare rank is reserved on each channel. The spare rank is used to copy the contents of a failing
rank on the channel to keep a system working when a rank starts to fail. The reserved rank is not able to be
used before the other rank fail.

Memory Identification

Generally, there are some memory information printed on the label of DIMM, but different vendor may have different format. For example:

4 GB 2R×4 PC4-14900R xx xx xxx

1. Density

• 1 GB, 2 GB, 4 GB, 8 GB, 16 GB, 32 GB

2. Rank

- IR = Single Rank
- 2R = Dual Rank
- 4R = Quad Rank

3. Bit Organization

- This platform supports ×4 and ×8
- Note: It's not recommend to mix DIMM with different bit organization in one system

4. Speed

- PC4 12800 => DDR4-1600
- PC4 14900 => DDR4-1866
- PC4 17000 => DDR4-2133

Graphics Specifications

Emulex Pilot-III Server Management Controller

Memory: 16 MB dedicated

Main Features

- Integrated Graphics Core with 2D Hardware accelerator
- DDR-3 memory interface with 16MB memory
- Supports all display resolutions up to 1600 x 1200 16bpp @ 60 Hz
- High speed Integrated 24-bit RAMDAC
- Single lane PCle host interface running a Gen1 speed

Supported video modes

2D Mode	2D Vide	2D Video Mode Support							
	8 bpp	16 bpp	24 bpp	32 bpp					
640x480	Х	Х	Х	Х					
800x600	Х	Х	Х	Х					
1024x768	Х	Х	Х	Х					
1152x864	Х	Х	Х	Х					
1280x1024	Х	Х	Х	Х					
1600x1200**	Х	Х							



Power specifications

750 W / 1100 W AC Platinum-certified power supply

Efficiency						
Loading Minimum efficiency	100% y 91%	50% 94%		20% 90%		10% 82%
Power factor						
Output power Power factor	10% load >0.65	20% load >0.80		50% la >0.90	ad	100% load >0.95
AC input voltage r	ange					
110 Vac 220 Vac	Min 90 Vrms 180 Vrms 47 Hz	rated 100-127 Vrms 200-240 Vrms 50/60 Hz	Max 140 Vrms 264 Vrms 63 Hz		Start up Vac 85 Vac ± 4 Vac	Power off Vac 75 Vac ± 5 Vac
AC line holdup tim	ie					
750 W 1100 W	Loading 70% 70%	Holdup tin 12 msec 10 msec	ne			
AC Line Inrush						
Shall not exceed 55	A peak					
750 W DC Gold-ce	rtified power sup	ply				
Efficiency						
Loading Minimum efficiency	100% y 88%	50% 92%		20% 88%		10% 80%
DC input voltage						
Parameter DC voltage Input current	Min -40.5 Vdc 24A	Rated -48 Vdc / ·	-60 Vdc	VMax -75 Vd 12.5A	c	
DC holdup time						
Loading 70%	Holdup time 0.2 msec					

Acer server software utilities

Smart Console with optional iKVM management

Web-based management utility to simplify system management with embedded BMC, system monitoring and alerting, event handling, remote power control and KVM-over-IP. Smart Console is OS independent and offers virtual media through floppy, ODD, and removable disk.

- Note:
- The integrated BMC has support for basic and advanced server management features. Basic management feature are available by default. Advanced management features are enabled with the addition of an optionally installed RMM (Remote Management Module) module.
- Two concurrent web sessions from up to two different users is supported.



Smart Server Manager

Offers 24-7 monitoring for system health and performance.

- Delivers proactive event management features including system event logging, event handling from e-mail and SNMP Trap (PET) alerting
- Monitors onboard hardware, operating systems and virtual machines
- Allows remote control from KVM and Power control
- Satisfies management in web-based UI, role-based administration, and automated management scripts
- Remote firmware deployment and scheduled updates
- Customizable BIOS settings and deployment to networked nodes

Available options

Processors (up to 2)

Intel[®] Xeon[®] processor (Fourteen Core)

- E5-2697 v3 (35 MB L3 cache, 2.6 GHz, DDR4 2133/1866/1600 MHz, 145 W)
- E5-2695 v3 (35 MB L3 cache, 2.3 GHz, DDR4 2133/1866/1600 MHz, 120 W)

Intel[®] Xeon[®] processor (Twelve Core)

- E5-2690 v3 (30 MB L3 cache, 2.6 GHz, DDR4 2133/1866/1600 MHz, 135 W)
- E5-2680 v3 (30 MB L3 cache, 2.5 GHz, DDR4 2133/1866/1600 MHz, 120 W)
- E5-2670 v3 (30 MB L3 cache, 2.3 GHz, DDR4 2133/1866/1600 MHz, 120 W)
- E5-2650L v3 (30 MB L3 cache, 1.8 GHz, DDR4 2133/1866/1600 MHz, 65 W)

Intel[®] Xeon[®] processor (Ten Core)

- E5-2660 v3 (25 MB L3 cache, 2.6 GHz, DDR4 2133/1866/1600 MHz, 105 W)
- E5-2650 v3 (25 MB L3 cache, 2.3 GHz, DDR4 2133/1866/1600 MHz, 105 W)

Intel[®] Xeon[®] processor (Eight Core)

- E5-2640 v3 (20 MB L3 cache, 2.6 GHz, DDR4 1866/1600 MHz, 90 W)
- E5-2630 v3 (20 MB L3 cache, 2.4 GHz, DDR4 1866/1600 MHz, 85 W)
- E5-2630L v3 (20 MB L3 cache, 2.0 GHz, DDR4 1866/1600 MHz, 55 W)

Intel[®] Xeon[®] processor (Six Core)

- E5-2643 v3 (20 MB L3 cache, 3.4 GHz, DDR4 2133/1866/1600 MHz, 135 W)
- E5-2620 v3 (15 MB L3 cache, 2.4 GHz, DDR4 1866/1600 MHz, 85 W)
- E5-2609 v3 (15 MB L3 cache, 2.9 GHz, DDR4 1600 MHz, 85 W)
- E5-2603 v3 (15 MB L3 cache, 1.6 GHz, DDR4 1600 MHz, 85 W)

Intel[®] Xeon[®] processor (Quad Core)

• E5-2637 v3 (15 MB L3 cache, 3.5 GHz, DDR4 2133/1866/1600 MHz, 135 W)

Memory

Memory type Capacities	Registered / Load Reduced DDR4 ECC memory 8 / 16 GB DIMMs Registered
capacities	32 GB DIMMs Load Reduced
DIMM number	24
Max memory	768GB (LRDIMM) or 384 GB (RDIMM)

Note: 32GB LRDIMM availability may vary by region.



Hard drives

Type Enterprise SATA 3.5"	Interface, bandwidth 6 Gb/s	Capacities (RPM) 500 GB (7.2K) 1 TB (7.2K) 2 TB (7.2K) 3 TB (7.2K) 4 TB (7.2K) 6 TB (7.2K)
Enterprise SAS 3.5"	6 Gb/s	1 TB (7.2K) 2 TB (7.2K) 3 TB (7.2K) 4 TB (7.2K)
Enterprise SAS, 2.5"	6 Gb/s	6 TB (7.2K) 300 GB (15K) 300 GB (10K) 450 GB (15K) 450 GB (10K) 600 GB (15K) 600 GB (10K) 900 GB (10K) 1.2 TB (10K) 1.8 TB (10K)
Optical drive		
Туре	Slimline Super-Multi	
RAID support upgrades		
Model	Port number	RAID support
Model ESRT2 SW SATA RAID 5 Activation Key	Port number	RAID support 0, 1, 5, 10
Model ESRT2 SW SATA RAID 5 Activation Key Intel [®] RAID SSD Cache with Fast Path I/O 8-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports	Port number 8 internal ports	• •
Model ESRT2 SW SATA RAID 5 Activation Key Intel [®] RAID SSD Cache with Fast Path I/O 8-port 12Gb SAS RAID Module		0, 1, 5, 10
Model ESRT2 SW SATA RAID 5 Activation Key Intel [®] RAID SSD Cache with Fast Path I/O 8-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 4-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 8-port 12Gb SAS Entry Level RAID	8 internal ports	0, 1, 5, 10 0, 1, 5, 6, 10, 50, 60
Model ESRT2 SW SATA RAID 5 Activation Key Intel [®] RAID SSD Cache with Fast Path I/O 8-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 4-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 8-port 12Gb SAS Entry Level RAID Module (LSI 3008) 8-port (external) 12Gb SAS RAID Card (LSI 3108 ROC, 1GB DDR3, supports	8 internal ports 4 internal ports	0, 1, 5, 10 0, 1, 5, 6, 10, 50, 60 0, 1, 5, 6, 10, 50, 60
Model ESRT2 SW SATA RAID 5 Activation Key Intel® RAID SSD Cache with Fast Path I/O 8-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 4-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 8-port 12Gb SAS Entry Level RAID Module (LSI 3008) 8-port (external) 12Gb SAS RAID Card (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 4-port (internal)/4-port (external) 12Gb SAS RAID Card (LIS 3108 ROC, 1GB DDR3, supports	8 internal ports 4 internal ports 8 internal ports	0, 1, 5, 10 0, 1, 5, 6, 10, 50, 60 0, 1, 5, 6, 10, 50, 60 0, 1, 1E, 10, JBOD mode
Model ESRT2 SW SATA RAID 5 Activation Key Intel [®] RAID SSD Cache with Fast Path I/O 8-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 4-port 12Gb SAS RAID Module (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 8-port 12Gb SAS Entry Level RAID Module (LSI 3008) 8-port (external) 12Gb SAS RAID Card (LSI 3108 ROC, 1GB DDR3, supports Super-capacitor Module) 4-port (internal)/4-port (external) 12Gb SAS RAID Card	8 internal ports 4 internal ports 8 internal ports 8 external ports 4 internal ports + 4 external	0, 1, 5, 10 0, 1, 5, 6, 10, 50, 60 0, 1, 5, 6, 10, 50, 60 0, 1, 1E, 10, JBOD mode 0, 1, 5, 6, 10, 50, 60



Ethernet network cards and I/O modules

Model	Port number	Bandwidth
Intel® Ethernet Server Adapter I350-T2	2 (RJ-45)	1 Gb/s
Intel [®] Ethernet Converged Network Adapter X540-T1	1 (RJ-45)	10 Gb/s
Intel [®] Ethernet Converged Network Adapter X540-T2	2 (RJ-45)	10 Gb/s
Intel [®] Ethernet Converged Network Adapter X520-DA2*	2 (SFP+)	10 Gb/s
Intel [®] Ethernet Converged Network Adapter X520-SR1*	1	10 Gb/s
Intel [®] Ethernet Converged Network Adapter X520-SR2*	2	10 Gb/s
Intel [®] Ethernet Converged Network Adapter X520-LR1*	1	10 Gb/s
Ethernet I/O Module Intel [®] I350-AE4 GbE	4 (RJ-45)	1 Gb/s
Ethernet I/O Module Intel [®] X540-BT2 10GbE	2 (RJ-45)	10 Gb/s
Intel [®] 82599EB Ethernet I/O Module	2 (SFP+)	10 Gb/s
Intel [®] XL710-QDA1 Ethernet I/O Module*	1 (QSFP+)	40 Gb/s
Intel [®] XL710-QDA2 Ethernet I/O Module*	2 (QSFP+)	40 Gb/s

*Note: Intel's 10GbE and 40GbE cards vary in terms of their connector type.

Note: All cards marked (I/O module) indicate the card is inserted in the I/O module connector on the node. It does not use the standard PCIe slot

InfiniBand

Model	Port number	Bandwidth
FDR InfiniBand* ConnectX-3* I/O Module (Single Port)	1 (FDR)	56 Gb/s
FDR InfiniBand* ConnectX-3* I/O Module (Dual Port)	2 (FDR)	56 Gb/s
Note: All cards marked (I/O module) indicate the card is inserted in the I/O module connector on the node. It does		
not use the standard PCIe slot		

Management module

Model	Function
Remote Management Module Activation Key	Enables remote iKVM
Local Control Panel	Enhances the manageability

Service and support

Acer Servers offer a comprehensive service suite to take care of daily IT needs. Users can select the 3-year standard warranty or choose extended warranties and services.

In a continuing effort to improve the quality of our products, information in this document is subject to change without notice. Images shown are only representations of some of the configurations available for this model. Availability may vary depending on region.

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NOTE: Extension warranty services may vary by country. Please contact Acer authorized resellers for more information.